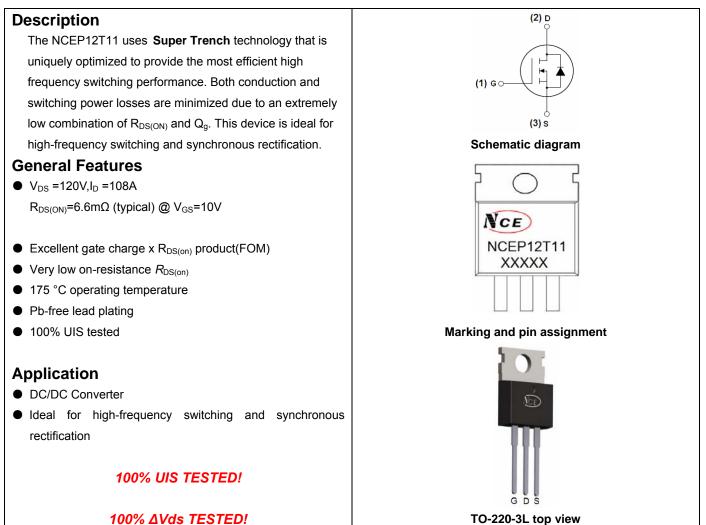


NCE N-Channel Super Trench Power MOSFET



Package Marking and Ordering Information

ſ	Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
	NCEP12T11	NCEP12T11	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	120	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι _D	108	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	78	А
Pulsed Drain Current	I _{DM}	380	А
Maximum Power Dissipation	PD	160	W
Derating factor		1.1	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	676	mJ
Operating Junction and Storage Temperature Range	TJ,TSTG	-55 To 175	°C



Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{θJC}	0.94	°C/W
--	------------------	------	------

Electrical Characteristics (T_C=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	I					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	120		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =120V,V _{GS} =0V	V _{DS} =120V,V _{GS} =0V -		1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·····		•			•
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.5	-	4.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =10V, I _D =50A	-	6.6	7.5	mΩ
Forward Transconductance	g fs	V _{DS} =10V,I _D =50A	40	-	-	S
Dynamic Characteristics (Note4)	· ·		·			
Input Capacitance	C _{lss}		-	4300	-	PF
Output Capacitance	C _{oss}	V _{DS} =50V,V _{GS} =0V, F=1.0MHz	-	790	-	PF
Reverse Transfer Capacitance	C _{rss}		-	47	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	13	-	nS
Turn-on Rise Time	tr	V _{DD} =60V,I _D =50A	-	58	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =4.7 Ω	-	39	-	nS
Turn-Off Fall Time	t _f		-	8	-	nS
Total Gate Charge	Qg		-	60		nC
Gate-Source Charge	Q _{gs}	V_{DS} =60V,I _D =50A,	-	21		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	11		nC
Drain-Source Diode Characteristics	· ·		·			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =108A	-		1.2	V
Diode Forward Current (Note 2)	I _S		-	-	108	Α
Reverse Recovery Time	trr	T_J = 25°C, I_F = I_S	-	60		nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	140		nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t \leq 10 sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

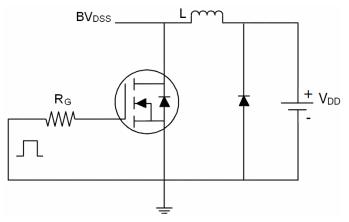
4. Guaranteed by design, not subject to production

5. EAS condition : Tj=25 $^\circ\!\mathrm{C}$,V_DD=50V,V_G=10V,L=0.5mH,Rg=25 Ω

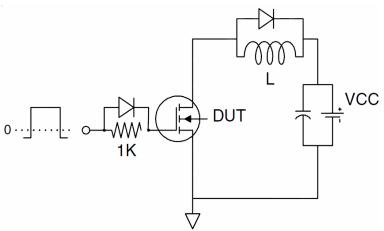


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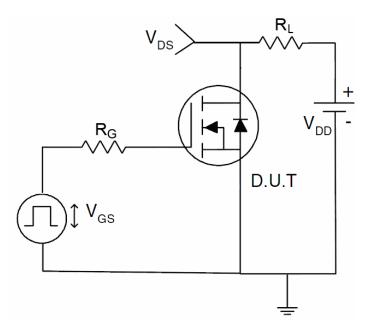
Test Circuit 1) E_{AS} test Circuit



2) Gate charge test Circuit

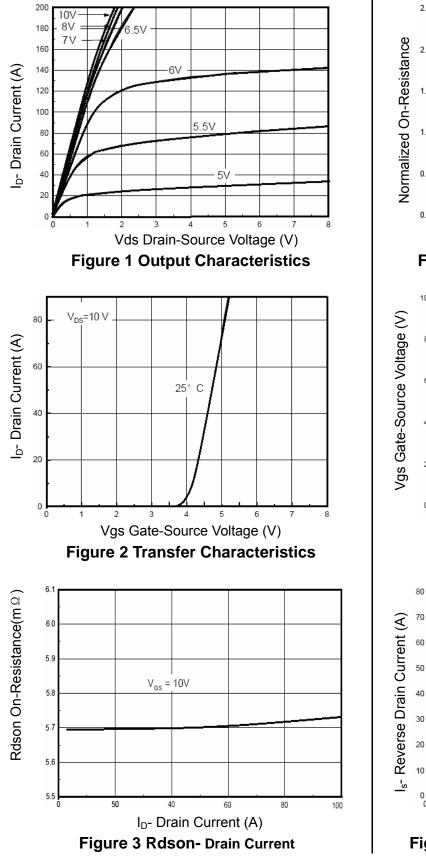


3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics



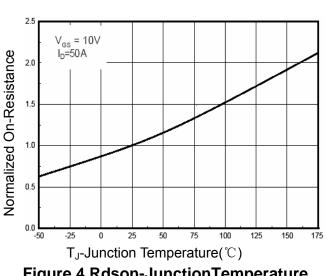


Figure 4 Rdson-JunctionTemperature

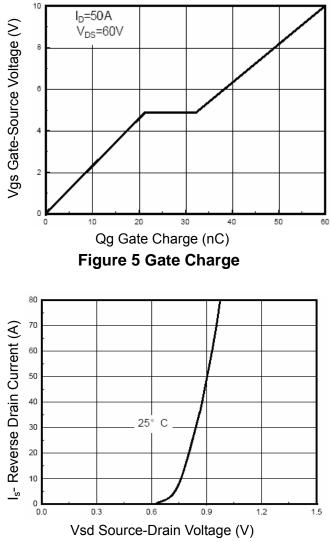


Figure 6 Source- Drain Diode Forward



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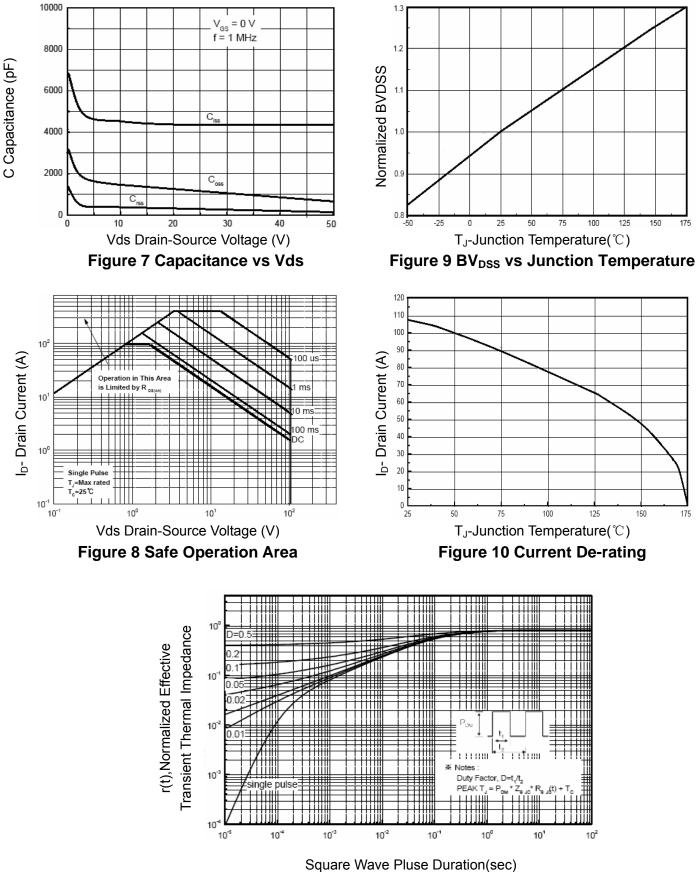
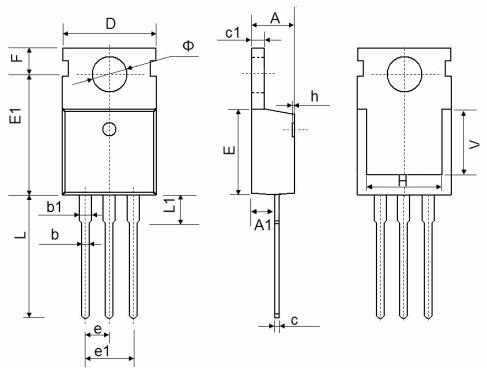


Figure 11 Normalized Maximum Transient Thermal Impedance



TO-220-3L Package Information



Or mark al	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	12.650 12.950 2.540 TYP.	0.100 TYP.			
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500 REF.		0.295 REF.		
Ф	3.400	3.800	0.134	0.150	



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